Docket No.:			
	DECLARATION AND P	OWER OF ATTORNEY	
As a below named inventor, l	í hereby declare that:		
My residence, post office and	l citizenship are as stated below next to n	ny name,	
are listed below) of the subject	est and sole inventor (if only one name is ct matter claimed and for which a patent DE RAY TUBE	listed below) or an original, first and joint inventis sought on the invention entitledthe specification of which	ntor (if plural names
[ X ] is attached hereto	[ ] was filed onamended on	_as Application Serial No and was	s
I hereby state that I have reviby any amendment referred t		e above identified specification, including the cla	aims, as amended
I acknowledge the duty to dis of Federal Regulations, Section		e to be material to patentability in accordance wi	ith Title 37, Code
certificate, or 365(a) of any P listed below and have also id-	CT international application which design	365 (b) of any foreign application(s) for patent or gnated at least one country other than the United foreign application for patent or inventor's certi pplication on which priority is claimed.	d States of America,
Prior Foreign Application( Number	(s): <u>Country</u>	Foreign Filing Date <u>Month/Day/Year</u>	
2000 / 26075	Korea	May / 16 / 2000	
Michy claim the benefit and	er 35 U.S.C. 119(e) of any United States	provisional application(s) listed below	
Application Number(s):	• • • • • • • • • • • • • • • • • • • •	te (Month/Day/Year)	
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	A Maria Maria		
The state of the s			
I-hereby claim the benefit un designating the United States not disclosed in the prior Un I acknowledge the duty to di	s of America, listed below and, insofar as nited States or PCT international applicat sclose information which is material to p	application(s), or 365(c) of any PCT internationals the subject matter of each of the claims of this ion in the manner provided by the first paragrap patentability as defined in 37 CFR 1.56 which be CT international filing date of this application.	application is oh of 35 U.S.C. 112,
Prior U. S. Application or PCT Parent Number	Filing Date (Month/Day/	/Year) Parent Patent Num	nber (if applicable)
	Filing Date (Month/Day)	<u>(Year)</u> <u>Parent Patent Nur</u>	nber (if applicable)

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s):Daniel Y.J. Kim, Registration No. 36,186 and Mark L. Fleshner, Registration No. 34,596; Carl R. Wesolowski, Registration No. 40,372, John C. Eisenhart, Registration No. 38,128, Rene A. Vazquez, Registration No. 38,647; Michael J. Cornelison, Registration No. 40,395; and Stuart I. Smith, Registration No. 42,159; and Carol L. Druzbick, Registration No. 40,287, all of

## FLESHNER & KIM P. O. Box 221200 Chantilly, Virginia 20153-1200

with full power of substitution and revocation, to prosecute this application an Office connected therewith, and all future correspondence should be addresse	
**************************************	
Full name of sole or first inventor: Sung Dae KIM	
Inventor's signature:	Date: 2001. 4.10
Residence: Taegu-Kwangyokshi, Korea	
Citizenship: Republic of Korea	
Post Office Address: Soojunghanyang APT., 201-80, 1370, Kwan Taegu-Kwangyokshi, Korea	
	**************************************
Full name of joint inventor(s):	
Inventor's signature:	Date:
Residence:	
Citizenship:	
Post Office Address: :	
	********************
Full name of joint inventor(s):	· · · · · · · · · · · · · · · · · · ·
Inventor's signature :	Date:
# ♣ Residence:	
Citizenship:	
Post Office Address:	
**************************	**************************************
Full name of joint inventor(s):	
Inventor's signature :	Date :
Residence:	
Citizenship:	
Post Office Address::	